

IC62LV12816L IC62LV12816LL



128K x 16 LOW VOLTAGE, ULTRA LOW POWER CMOS STATIC RAM

FEATURES

- High-speed access times: 55, 70, 100 ns
- CMOS low power operation
 - 60 mW (typical) operating
 - 3 μ W (typical) CMOS standby
- TTL compatible interface levels
- Single 2.7V-3.6V Vcc power supply
- Fully static operation: no clock or refresh required
- Three state outputs
- Data control for upper and lower bytes
- Industrial temperature available
- Available in the 44-pin TSOP-2 and 48-pin 6*8mm TF-BGA

DESCRIPTION

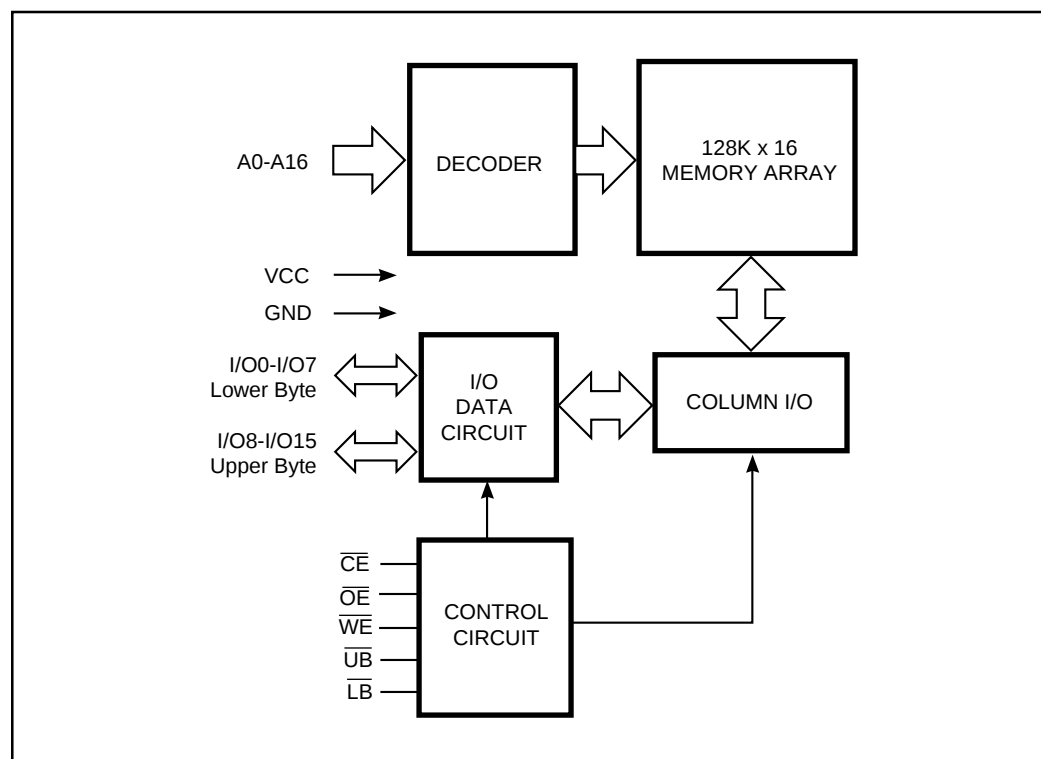
The *ICSI* IC62LV12816L and IC62LV12816LL are high-speed, 2,097,152-bit static RAMs organized as 131,072 words by 16 bits. They are fabricated using *ICSI*'s high-performance CMOS technology. This highly reliable process coupled with innovative circuit design techniques, yields high-performance and low power consumption devices.

When $\overline{CE}$ is HIGH (deselected) or when $\overline{CE}$ is low and both $\overline{LB}$ and $\overline{UB}$ are HIGH, the device assumes a standby mode at which the power dissipation can be reduced by using CMOS input levels.

Easy memory expansion is provided by using Chip Enable Output and Enable inputs, $\overline{CE}$ and $\overline{OE}$. The active LOW Write Enable ($\overline{WE}$) controls both writing and reading of the memory. A data byte allows Upper Byte ($\overline{UB}$) and Lower Byte ($\overline{LB}$) access.

The IC62LV12816L and IC62LV12816LL are packaged in the JEDEC standard 44-pin 400mil TSOP-2 and 48-pin 6*8mm TF-BGA.

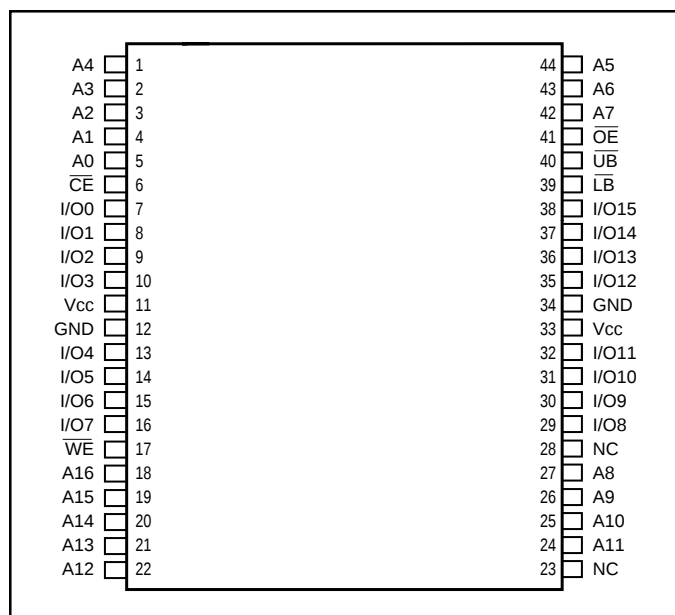
FUNCTIONAL BLOCK DIAGRAM



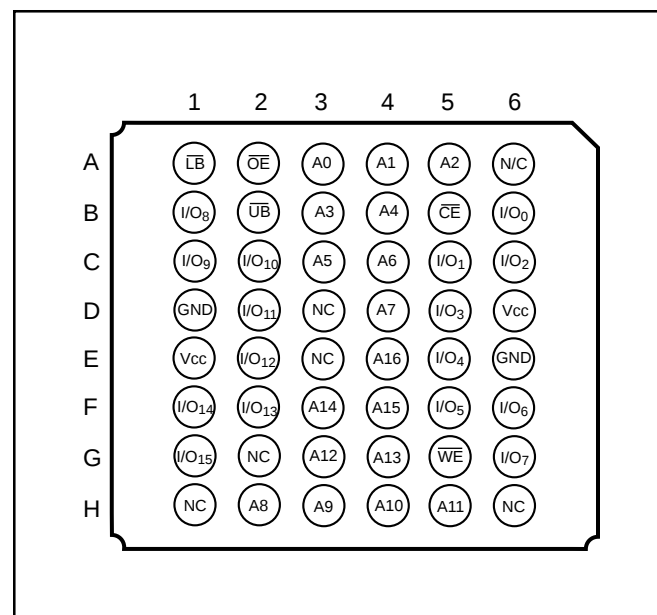
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PIN CONFIGURATIONS

44-Pin TSOP-2



48-Pin TF-BGA



PIN DESCRIPTIONS

A0-A16	Address Inputs
I/O0-I/O15	Data Input/Output
$\overline{CE}$	Chip Enable Input
$\overline{OE}$	Output Enable Input
$\overline{WE}$	Write Enable Input

$\overline{LB}$	Lower-byte Control (I/O0-I/O7)
$\overline{UB}$	Upper-byte Control (I/O8-I/O15)
NC	No Connection
Vcc	Power
GND	Ground

TRUTH TABLE

Mode						I/O PIN		Vcc Current
	$\overline{WE}$	$\overline{CE}$	$\overline{OE}$	$\overline{LB}$	$\overline{UB}$	I/O0-I/O7	I/O8-I/O15	
Not Selected	X	H	X	X	X	High-Z	High-Z	ISB1, ISB2
	X	L	X	H	H	High-Z	High-Z	ISB1, ISB2
Output Disabled	H	L	H	X	X	High-Z	High-Z	Icc
	X	L	X	H	H	High-Z	High-Z	ISB
Read	H	L	L	L	H	DOUT	High-Z	Icc
	H	L	L	H	L	High-Z	DOUT	
	H	L	L	L	L	DOUT	DOUT	
Write	L	L	X	L	H	DIN	High-Z	Icc
	L	L	X	H	L	High-Z	DIN	
	L	L	X	L	L	DIN	DIN	

OPERATING RANGE

Range	Ambient Temperature	V _{CC}
Commercial	0°C to +70°C	2.7V - 3.6V
Industrial	-40°C to +85°C	2.7V - 3.6V

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Parameter	Value	Unit
V _{TERM}	Terminal Voltage with Respect to GND	-0.5 to V _{CC} + 0.5	V
T _{BIAS}	Temperature Under Bias	-40 to +85	°C
V _{CC}	V _{CC} related to GND	-0.3 to +4.0	V
T _{STG}	Storage Temperature	-65 to +150	°C
P _T	Power Dissipation	1.0	W

Notes:

1. Stress greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

DC ELECTRICAL CHARACTERISTICS (Over Operating Range)

Symbol	Parameter	Test Conditions	Min.	Max.	Unit
V _{OH}	Output HIGH Voltage	V _{CC} = Min., I _{OH} = -1 mA	2.0	—	V
V _{OL}	Output LOW Voltage	V _{CC} = Min., I _{OL} = 2.1 mA	—	0.4	V
V _{IH}	Input HIGH Voltage		2.2	V _{CC} + 0.2	V
V _{IL} ⁽¹⁾	Input LOW Voltage ⁽¹⁾		-0.2	0.4	V
I _{LI}	Input Leakage	GND ≤ V _{IN} ≤ V _{CC}	-1	1	μA
I _{LO}	Output Leakage	GND ≤ V _{OUT} ≤ V _{CC} , OUTPUTS DISABLED	-1	1	μA

Notes:

1. V_{IL}(min.) = -2.0V for pulse width less than 10 ns.

CAPACITANCE⁽¹⁾

Symbol	Parameter	Conditions	Max.	Unit
C _{IN}	Input Capacitance	V _{IN} = 0V	6	pF
C _{OUT}	Output Capacitance	V _{OUT} = 0V	8	pF

Notes:

1. Tested initially and after any design or process changes that may affect these parameters.

AC TEST CONDITIONS

Parameter	Unit
Input Pulse Level	0.4V to 2.2V
Input Rise and Fall Times	5 ns
Input and Output Timing and Reference Level	1.3V
Output Load	See Figures 1 and 2

AC TEST LOADS

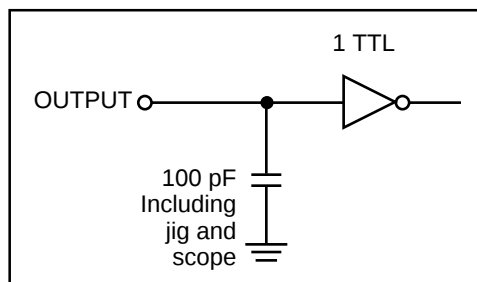


Figure 1

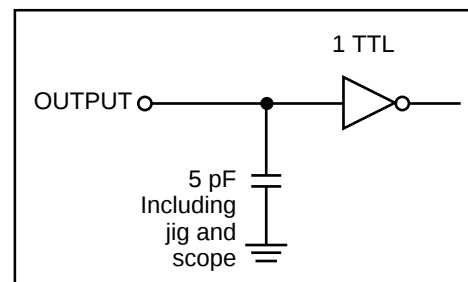


Figure 2

IC62LV12816L POWER SUPPLY CHARACTERISTICS⁽¹⁾ (Over Operating Range)

Symbol	Parameter	Test Conditions		-55		-70		-100		Unit
				Min.	Max.	Min.	Max.	Min.	Max.	
I _{CC}	V _{CC} Dynamic Operating Supply Current	V _{CC} = Max., I _{OUT} = 0 mA, f = f _{MAX}	Com. Ind.	— —	40 45	— —	30 35	— —	20 25	mA
I _{SB1}	TTL Standby Current (TTL Inputs)	V _{CC} = Max., V _{IN} = V _{IH} or V _{IL} , $\overline{CE} \leq V_{IH}$, f = 0	Com. Ind.	— —	0.5 1.0	— —	0.5 1.0	— —	0.5 1.0	mA
	OR									
	ULB Control	V _{CC} = Max., V _{IN} = V _{IH} or V _{IL} , $\overline{CE} = V_{IL}$, f = 0, $\overline{UB} = V_{IH}$, $\overline{LB} = V_{IH}$								
I _{SB2}	CMOS Standby Current (CMOS Inputs)	V _{CC} = Max., $\overline{CE} \geq V_{CC} - 0.2V$, V _{IN} ≥ V _{CC} - 0.2V, or V _{IN} ≤ 0.2V, f = 0	Com. Ind.	— —	35 50	— —	35 50	— —	35 50	μA
	OR									
	ULB Control	V _{CC} = Max., $\overline{CE} = V_{IL}$, V _{IN} ≤ 0.2V, f = 0, $\overline{UB} / \overline{LB} = V_{CC} - 0.2V$								

Note:

1. At f = f_{MAX}, address and data inputs are cycling at the maximum frequency, f = 0 means no input lines change.

IC62LV12816LL POWER SUPPLY CHARACTERISTICS⁽¹⁾ (Over Operating Range)

Symbol	Parameter	Test Conditions		-55		-70		-100		Unit
				Min.	Max.	Min.	Max.	Min.	Max.	
I _{CC}	V _{CC} Dynamic Operating Supply Current	V _{CC} = Max.,	Com.	—	40	—	30	—	20	mA
		I _{OUT} = 0 mA, f = f _{MAX}	Ind.	—	45	—	35	—	25	
I _{SB1}	TTL Standby Current (TTL Inputs)	V _{CC} = Max., V _{IN} = V _{IH} or V _{IL} , CE ≥ V _{IH} , f = 0	Com.	—	0.5	—	0.5	—	0.5	mA
		Ind.	—	1.0	—	1.0	—	1.0		
	OR									
	ULB Control	V _{CC} = Max., V _{IN} = V _{IH} or V _{IL} CE = V _{IL} , f = 0, UB = V _{IH} , LB = V _{IH}								
I _{SB2}	CMOS Standby Current (CMOS Inputs)	V _{CC} = Max., f = 0 CE ≥ V _{CC} − 0.2V, V _{IN} ≥ V _{CC} − 0.2V, or V _{IN} ≤ 0.2V, f = 0	Com.	—	10	—	10	—	10	μA
		Ind.	—	15	—	15	—	15		
	OR									
	ULB Control	V _{CC} = Max., CE = V _{IL} V _{IN} ≤ 0.2V, f = 0, UB / LB = V _{CC} − 0.2V								

Note:

- At f = f_{MAX}, address and data inputs are cycling at the maximum frequency, f = 0 means no input lines change.

READ CYCLE SWITCHING CHARACTERISTICS⁽¹⁾ (Over Operating Range)

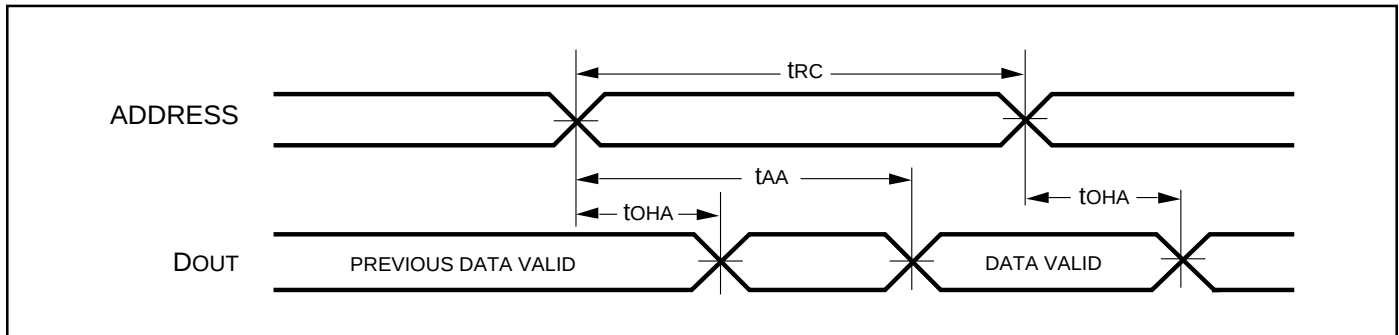
Symbol	Parameter	-55		-70		-100		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	
t _{RC}	Read Cycle Time	55	—	70	—	100	—	ns
t _{AA}	Address Access Time	—	55	—	70	—	100	ns
t _{OH}	Output Hold Time	10	—	10	—	15	—	ns
t _{ACE}	CE Access Time	—	55	—	70	—	100	ns
t _{DOE}	OE Access Time	—	30	—	35	—	50	ns
t _{HZOE} ⁽²⁾	OE to High-Z Output	—	20	—	25	—	30	ns
t _{LZOE} ⁽²⁾	OE to Low-Z Output	5	—	5	—	5	—	ns
t _{HZCE} ⁽²⁾	CE to High-Z Output	0	20	0	25	0	30	ns
t _{LZCE} ⁽²⁾	CE to Low-Z Output	10	—	10	—	10	—	ns
t _{BA}	LB, UB Access Time	—	55	—	70	—	100	ns
t _{HZB}	LB, UB to High-Z Output	0	25	0	25	0	35	ns
t _{LZB}	LB, UB to Low-Z Output	0	—	0	—	0	—	ns

Notes:

- Test conditions assume signal transition times of 5 ns or less, timing reference levels of 1.3V, input pulse levels of 0.4V to 2.2V and output loading specified in Figure 1.
- Tested with the load in Figure 2. Transition is measured ±500 mV from steady-state voltage. Not 100% tested.

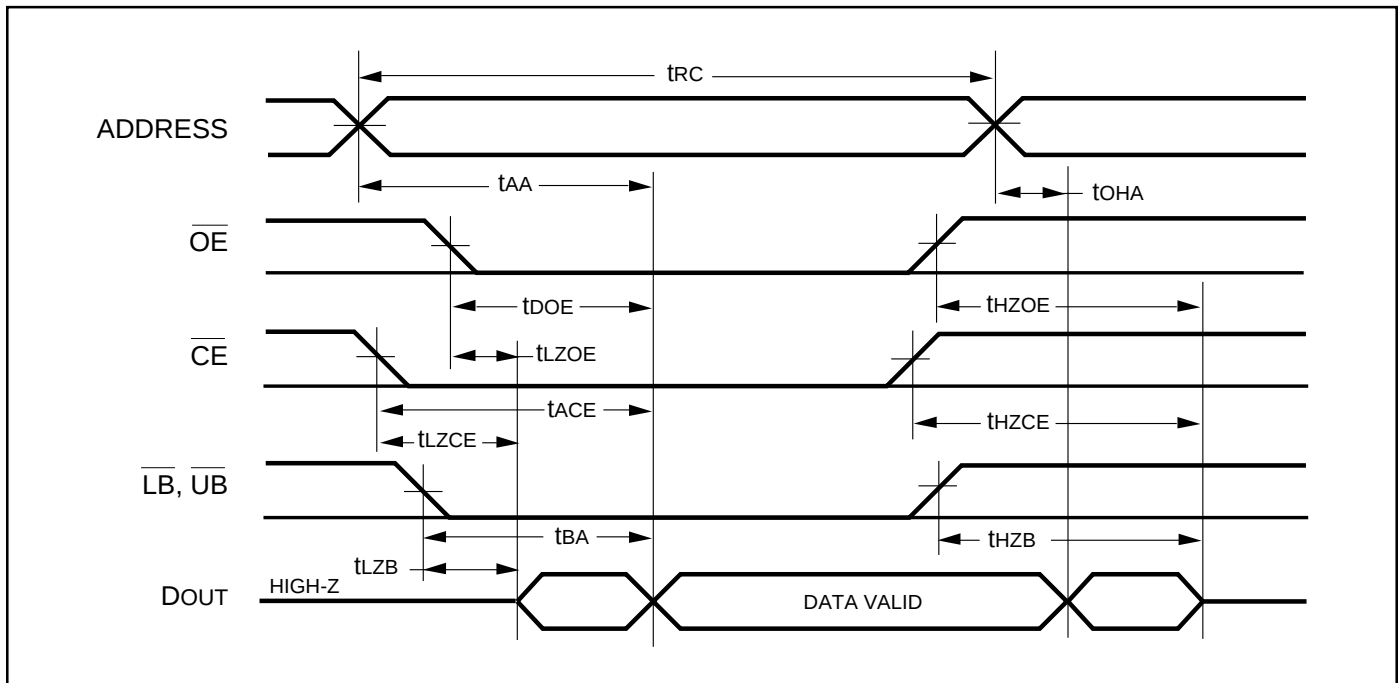
AC TEST LOADS

READ CYCLE NO.1^(1,2) (Address Controlled) ($\overline{CE} = \overline{OE} = V_{IL}$, $\overline{UB}$ or $\overline{LB} = V_{IL}$)



AC WAVEFORMS

READ CYCLE NO. 2^(1,3) ($\overline{CS}$, $\overline{OE}$, AND $\overline{UB}/\overline{LB}$ Controlled)



Notes:

1. $\overline{WE}$ is HIGH for a Read Cycle.
2. The device is continuously selected. $\overline{OE}$, $\overline{CE}$, $\overline{UB}$, or $\overline{LB} = V_{IL}$.
3. Address is valid prior to or coincident with $\overline{CE}$ LOW transitions.

WRITE CYCLE SWITCHING CHARACTERISTICS^(1,2) (Over Operating Range)

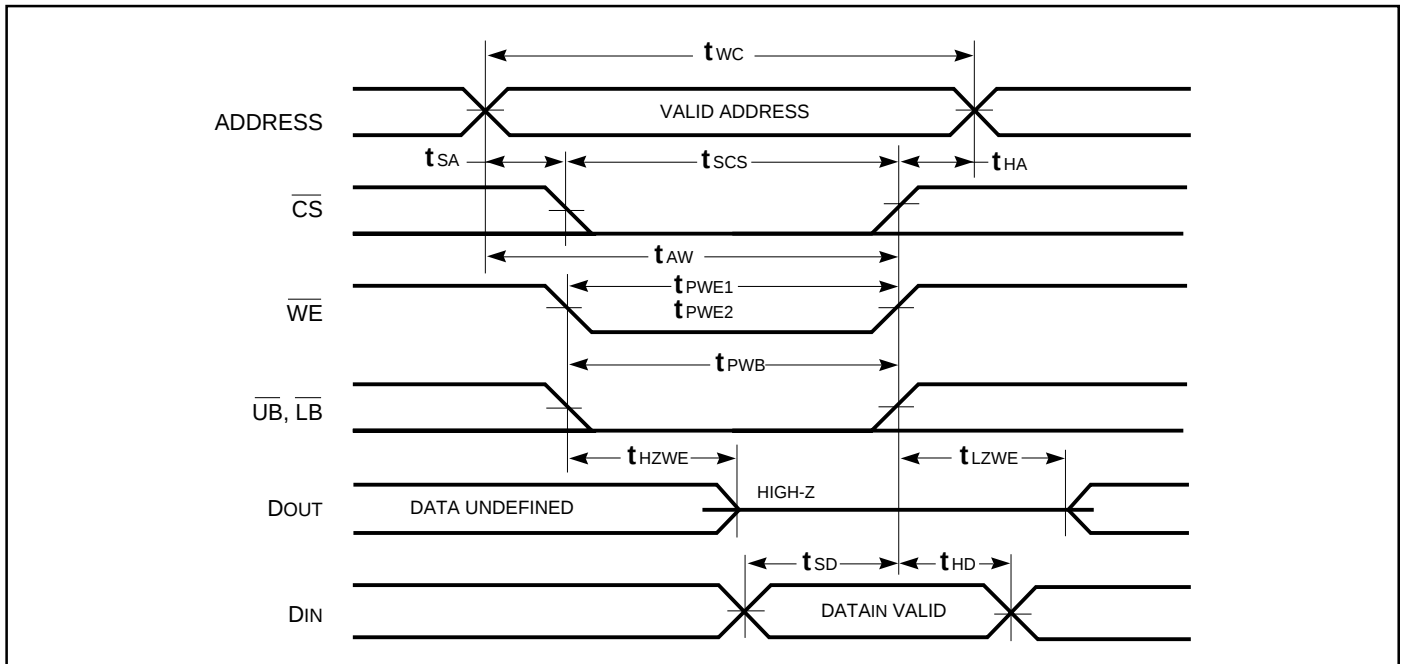
Symbol	Parameter	-55		-70		-100		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	
t _{WC}	Write Cycle Time	55	—	70	—	100	—	ns
t _{SCE}	$\overline{CE}$ to Write End	50	—	65	—	80	—	ns
t _{AW}	Address Setup Time to Write End	50	—	65	—	80	—	ns
t _{HA}	Address Hold from Write End	0	—	0	—	0	—	ns
t _{SA}	Address Setup Time	0	—	0	—	0	—	ns
t _{PWB}	$\overline{LB}$, $\overline{UB}$ Valid to End of Write	45	—	60	—	80	—	ns
t _{PWE⁽⁴⁾}	$\overline{WE}$ Pulse Width	40	—	40	—	80	—	ns
t _{SD}	Data Setup to Write End	25	—	30	—	40	—	ns
t _{HD}	Data Hold from Write End	0	—	0	—	0	—	ns
t _{HZWE⁽³⁾}	$\overline{WE}$ LOW to High-Z Output	—	30	—	30	—	40	ns
t _{LZWE⁽³⁾}	$\overline{WE}$ HIGH to Low-Z Output	5	—	5	—	5	—	ns

Notes:

1. Test conditions assume signal transition times of 3 ns or less, timing reference levels of 1.3V, input pulse levels of 0.4V to 2.2V and output loading specified in Figure 1.
2. The internal write time is defined by the overlap of $\overline{CE}$ LOW, and $\overline{UB}$ or $\overline{LB}$, and $\overline{WE}$ LOW. All signals must be in valid states to initiate a Write, but any one can go inactive to terminate the Write. The Data Input Setup and Hold timing are referenced to the rising or falling edge of the signal that terminates the Write.
3. Tested with the load in Figure 2. Transition is measured ± 500 mV from steady-state voltage. Not 100% tested.
4. Tested with $\overline{OE}$ HIGH

AC WAVEFORMS

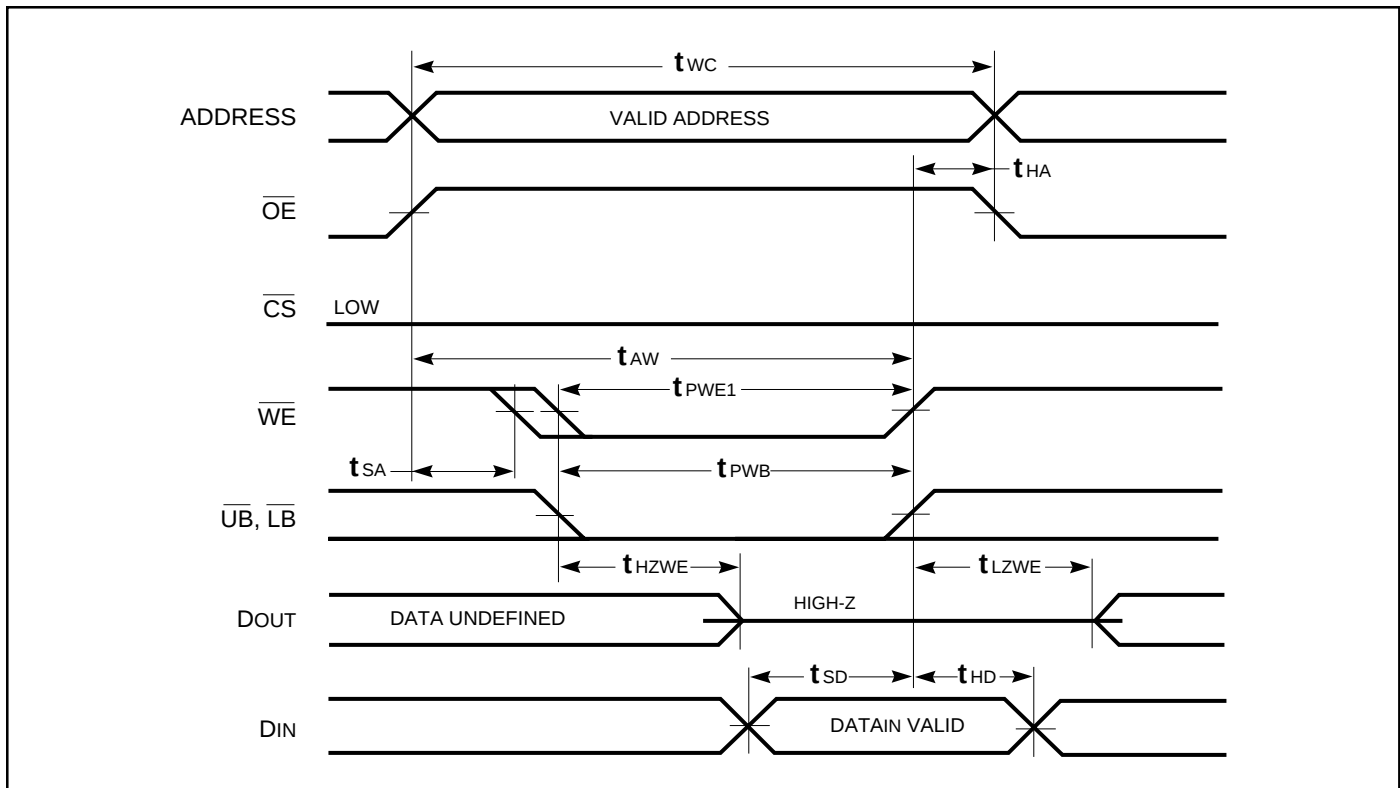
WRITE CYCLE NO. 1^(1,2) ($\overline{CS}$, Controlled, $\overline{OE}$ = HIGH or LOW)



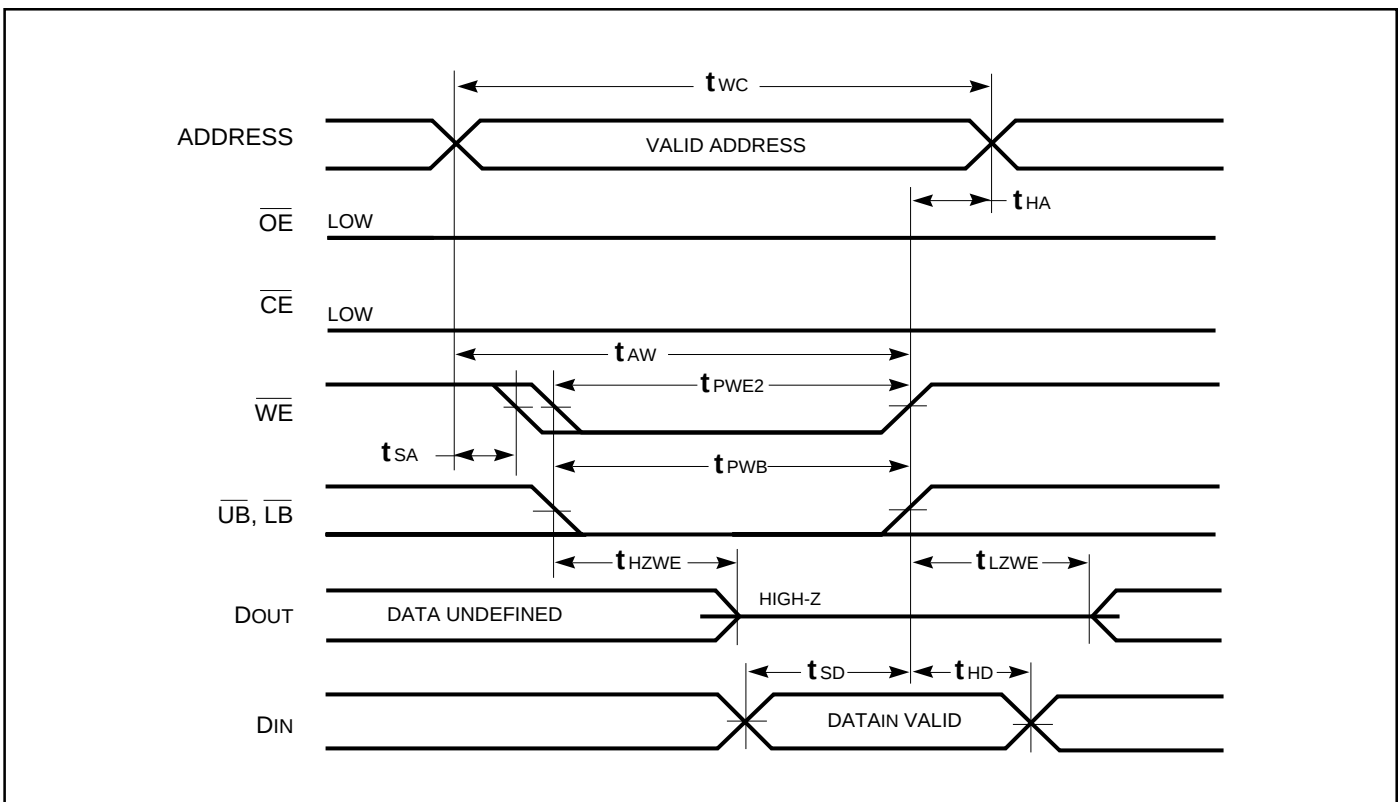
Notes:

1. WRITE is an internally generated signal asserted during an overlap of the LOW states on the $\overline{CS}$ and $\overline{WE}$ inputs and at least one of the $\overline{LB}$ and $\overline{UB}$ inputs being in the LOW state.
2. WRITE = ($\overline{CS}$) [($\overline{LB}$) = ($\overline{UB}$)] ($\overline{WE}$).

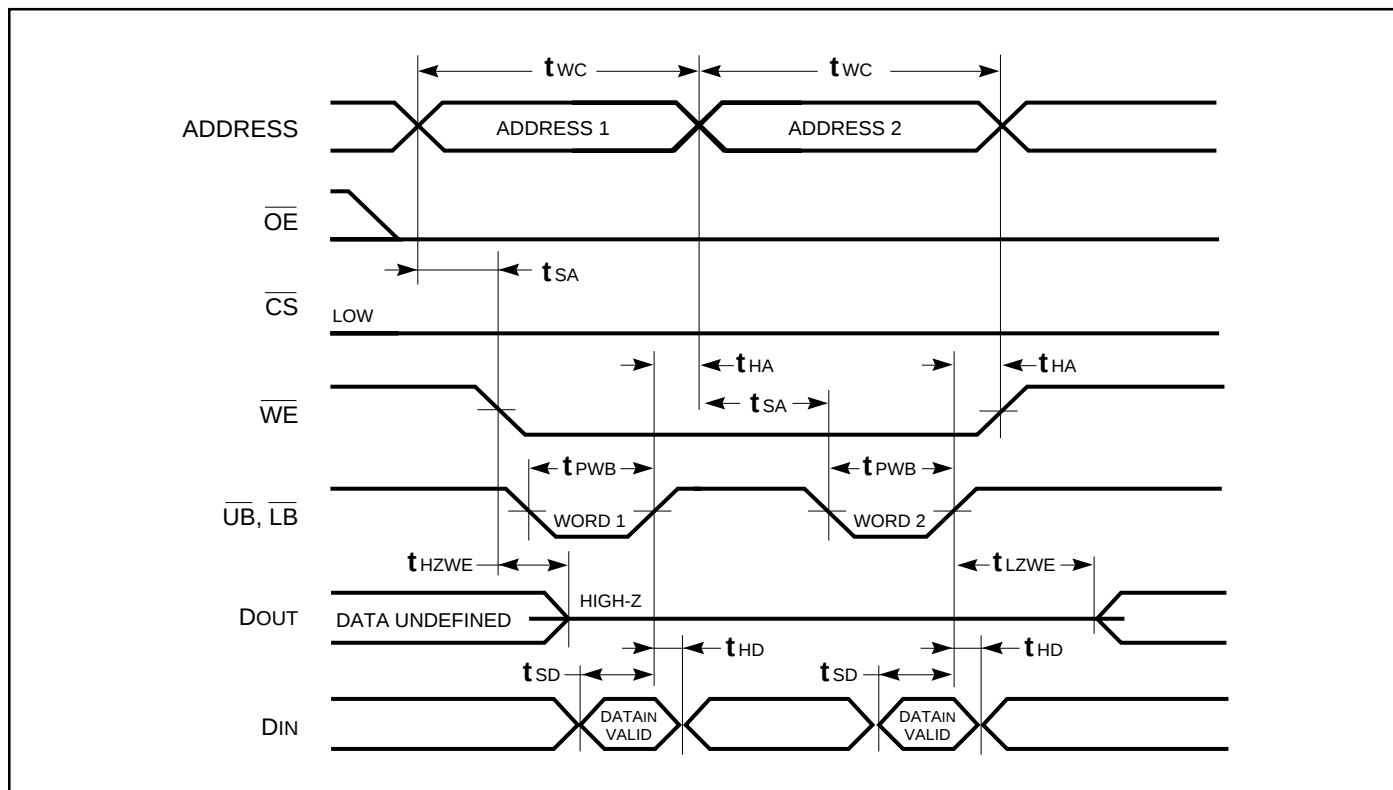
WRITE CYCLE NO. 2 ($\overline{WE}$ Controlled; $\overline{OE}$ is HIGH During Write Cycle)



WRITE CYCLE NO. 3 ($\overline{WE}$ Controlled; $\overline{OE}$ is LOW During Write Cycle)



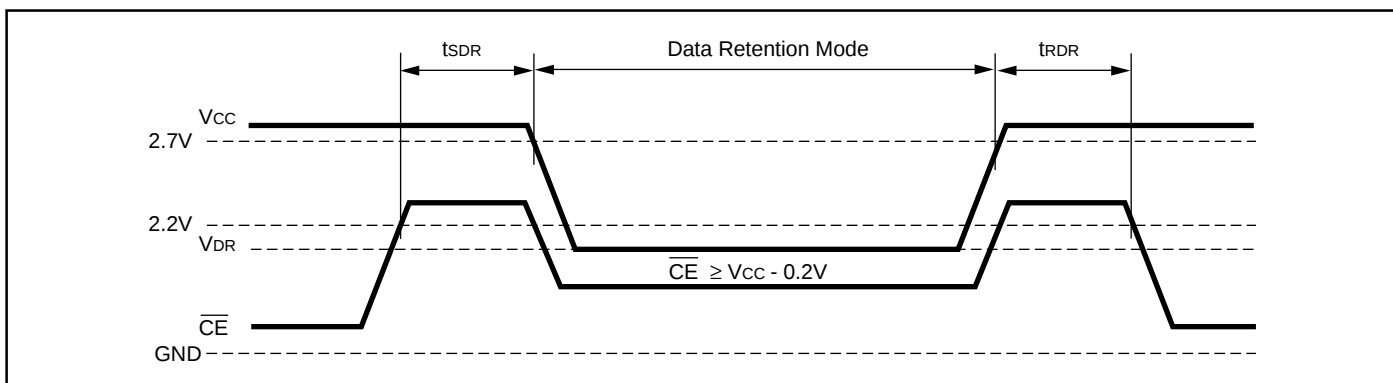
WRITE CYCLE NO. 4 ($\overline{UB}$ / $\overline{LB}$ Controlled)



DATA RETENTION SWITCHING CHARACTERISTICS (L/LL)

Symbol	Parameter	Test Condition	Min.	Max.	Unit
V_{DR}	V_{CC} for Data Retention	See Data Retention Waveform	1.5	3.6	V
I_{DR}	Data Retention Current	$V_{CC} = 2.0V, \overline{CE} \geq V_{CC} - 0.2V$	Com. (-L)	—	20 μA
			Com. (-LL)	—	5 μA
			Ind. (-L)	—	25 μA
			Ind. (-LL)	—	7 μA
t_{SDR}	Data Retention Setup Time	See Data Retention Waveform	0	—	ns
t_{RDR}	Recovery Time	See Data Retention Waveform	t_{RC}	—	ns

DATA RETENTION WAVEFORM ($\overline{CE}$ Controlled)



ORDERING INFORMATION

Commercial Range: 0°C to +70°C

Speed (ns)	Order Part No.	Package
55	IC62LV12816L-55T	400mil TSOP-2
	IC62LV12816L-55B	6*8mm TF-BGA
70	IC62LV12816L-70T	400mil TSOP-2
	IC62LV12816L-70B	6*8mm TF-BGA
100	IC62LV12816L-100T	400mil TSOP-2
	IC62LV12816L-100B	6*8mm TF-BGA

Industrial Range: -40°C to +85°C

Speed (ns)	Order Part No.	Package
55	IC62LV12816L-55TI	400mil TSOP-2
	IC62LV12816L-55BI	6*8mm TF-BGA
70	IC62LV12816L-70TI	400mil TSOP-2
	IC62LV12816L-70BI	6*8mm TF-BGA
100	IC62LV12816L-100TI	400mil TSOP-2
	IC62LV12816L-100BI	6*8mm TF-BGA

ORDERING INFORMATION

Commercial Range: 0°C to +70°C

Speed (ns)	Order Part No.	Package
55	IC62LV12816LL-55T	400mil TSOP-2
	IC62LV12816LL-55B	6*8mm TF-BGA
70	IC62LV12816LL-70T	400mil TSOP-2
	IC62LV12816LL-70B	6*8mm TF-BGA
100	IC62LV12816LL-100T	400mil TSOP-2
	IC62LV12816LL-100B	6*8mm TF-BGA

Industrial Range: -40°C to +85°C

Speed (ns)	Order Part No.	Package
55	IC62LV12816LL-55TI	400mil TSOP-2
	IC62LV12816LL-55BI	6*8mm TF-BGA
70	IC62LV12816LL-70TI	400mil TSOP-2
	IC62LV12816LL-70BI	6*8mm TF-BGA
100	IC62LV12816LL-100TI	400mil TSOP-2
	IC62LV12816LL-100BI	6*8mm TF-BGA



Integrated Circuit Solution Inc.

HEADQUARTER:

NO.2, TECHNOLOGY RD. V, SCIENCE-BASED INDUSTRIAL PARK,
HSIN-CHU, TAIWAN, R.O.C.

TEL: 886-3-5780333

Fax: 886-3-5783000

BRANCH OFFICE:

7F, NO. 106, SEC. 1, HSIN-TAI 5TH ROAD,
HSICHIH TAIPEI COUNTY, TAIWAN, R.O.C.

TEL: 886-2-26962140

FAX: 886-2-26962252

<http://www.icsi.com.tw>